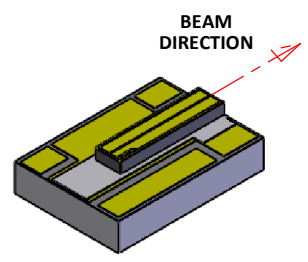
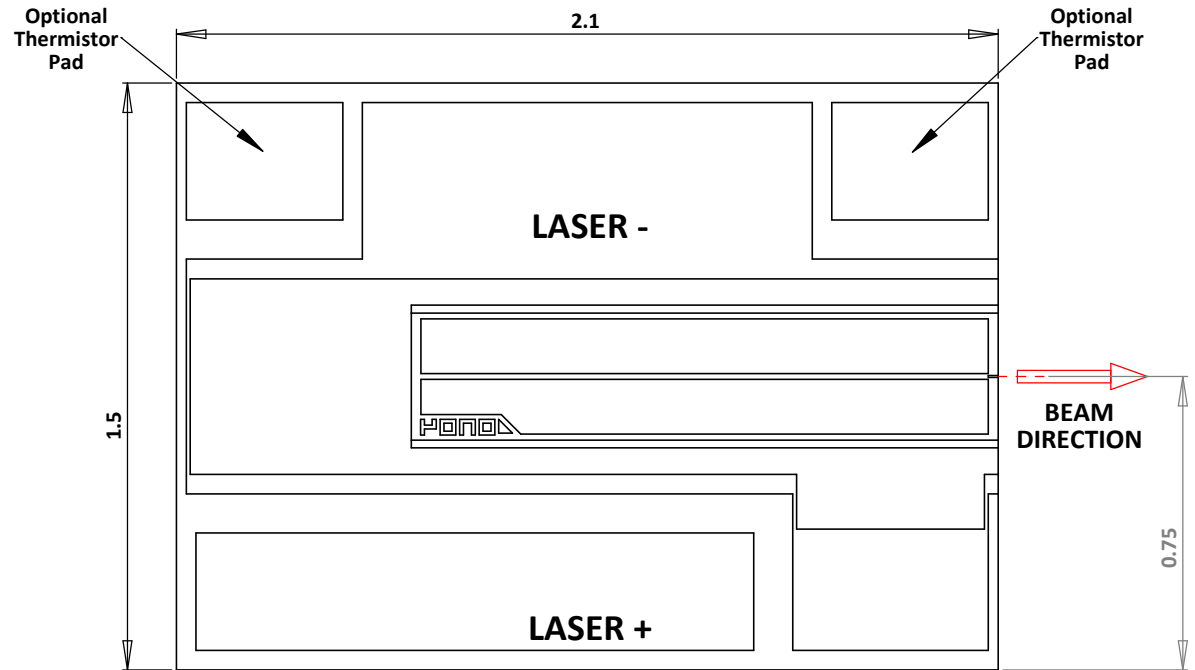
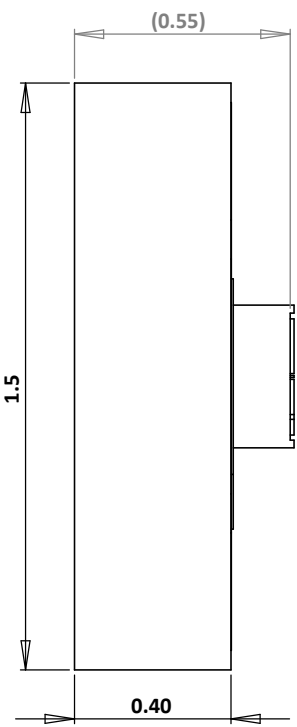


REVISIONS			
REV.	DESCRIPTION	DATE	APPROVED
01	INITIAL RELEASE	07/13/2016	BP
A	ECO #	07/27/2016	BP



- NOTES:**
- Reference Chip size, 1.5mm X.35mm
 - Maximum processing temperature 250°C

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DIMENSIONS mm [in]	NAME	DATE
UNLESS OTHERWISE SPECIFIED TOLERANCES ARE:	DRAWN	BP 11/21/2006
ANGULAR: ± 30 MINUTES	CHECKED	
X ± .25 [.010]	ENG APPR.	~
X.X ± .13 [.005]	MFG APPR.	~
X.XX ± .05 [.002]	Q.A.	~
X.XXX ± .025 [.001]		
INTERPRET GEOMETRIC TOLERANCING PER: ASME Y14.5M-1994	THIRD ANGLE PROJECTION	
MATERIAL		
NA		
FINISH (UNLESS OTHERWISE SPECIFIED)		
DO NOT SCALE DRAWING		

SHEAUMANN

TITLE: **C2 MOUNT, TYP**

SIZE	DWG. NO.	REV
B	RDW 840032	A

SCALE: 1:0.2 SHEET 1 OF 1